# M54HC4538 M74HC4538

NOZMOHT-Z D Z

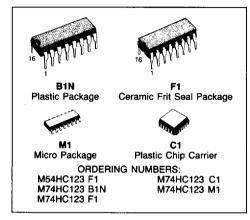
# DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATOR

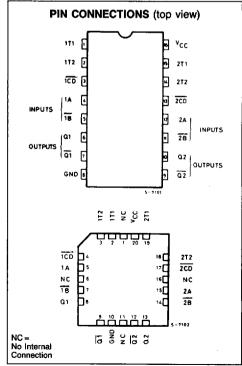
- HIGH SPEED ten = 27 ns (TYP) at Vcc = 5V
- LOW POWER DISSIPATION STANDBY STATE  $I_{CC} = 4 \mu A$  (MAX.) at  $T_A = 25^{\circ}C$ ACTIVE STATE I<sub>CC</sub> = 200  $\mu$ A (TYP) at V<sub>CC</sub> = 5V
- HIGH NOISE IMMUNITY  $V_{NIH} = V_{NIL} = 28\% V_{CC} (MIN.)$
- **OUTPUT DRIVE CAPABILITY** 10 LSTTL LOADS
- BALANCED PROPAGATION DELAYS tplH = tpHL
- WIDE OUTPUT PULSE WIDTH RANGE  $t_{WOUT}$  = 120ns ~ 60s over at  $V_{CC}$  = 4.5V
- OUTPUT PULSE WIDTH INDEPENDENT FROM TRIGGER INPUT PULSE WIDTH.
- PIN AND FUNCTION COMPATIBLE WITH 4538B

#### DESCRIPTION

The M54/74HC4538 is a high speed CMOS DUAL MONOSTABLE MULTIVIBRATOR fabricated in silicon gate C2MOS technology. It has the same high speed performance of LSTTL combined with true CMOS low power consumption. Each multivibrator features both a negative, A, and a positive, B, edge triggered input, either of which can be used as an inhibt input. Also included is a clear input that when taken low resets the one shot. The monostable multivibrators are retriggerable. That is, they may be triggered reapeatedly while their outputs are generating a pulse and the pulse will be extended. Pulse width stability over a wide range of temperature and supply is achieved using linear CMOS techniques. The output pulse equation is simply: PW = 0.7 (R)(C) where PW is in seconds. R in Ohms, and C is in Farads.

All inputs are equipped with protection circuits against static discharge and transient excess voltage.





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### **TRUTH TABLE**

	INPUTS		ОПТІ	PUTS	
A	B	CD	Q	ā	NOTE
	Н	н			OUTPUT ENABLE
x	L	н	L	н	INHIBIT
н	х	Н	L	н	INHIBIT
L	Ł	Н			OUTPUT ENABLE
х	х	L	L	н	INHIBIT

X: DON'T CARE

### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	-0.5 to 7	٧
Vi	DC Input Voltage	-0.5 to V <sub>CC</sub> +0.5	٧
v <sub>o</sub>	DC Output Voltage	-0.5 to V <sub>CC</sub> +0.5	٧
lık	DC Input Diode Current	± 20	mA
loк	DC Output Diode Current	± 20	mA
l <sub>o</sub>	DC Output Source Sink Current Per Output Pin	± 25	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	± 50	mA
PD	Power Dissipation	500 (*)	mW
T <sub>stg</sub>	Storage Temperature	- 65 to 150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

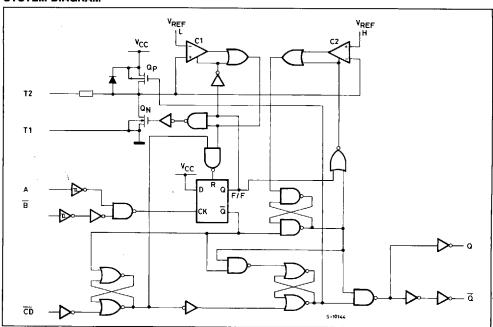
(\*) 500 mW: ≅ 65°C derate to 300 mW by 10 mW/°C: 65°C to 85°C

### RECOMMENDED OPERATING CONDITIONS

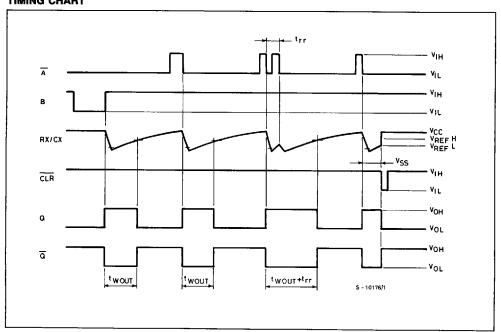
Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	2 to 6	V
VI	Input Voltage	0 to V <sub>CC</sub>	٧
Vo	Output Voltage	0 to V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature 74HC Series 54HC Series	- 40 to 85 - 55 to 125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (CLR only)	V <sub>CC</sub>	ns
Cx	External Capacitor	NO LIMITATION	
Rx	External Resistor	V <sub>CC</sub> {3 V 5K to 1M 1K to 1M	Ω

# SYSTEM DIAGRAM

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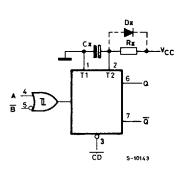


### **TIMING CHART**

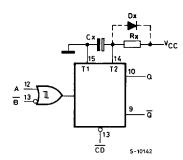


### **BLOCK DIAGRAM**

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#### Note:

- (1) Cx, Rx, Dx are external components.
- (2) Dx is a clamping diode

The external capacitor is charged to  $V_{\rm CC}$  in the stand-by state, i.e. no trigger. When the supply voltage is turned off Cx is discharged mainly through an internal parasitic diode (see figures). If Cx is sufficiently large and  $V_{\rm CC}$  decreases rapidy, there will be some possibility of damaging the I.C. with a surge current or latch-up. If the voltage supply filter capacitor is large enough and  $V_{\rm CC}$  decrease slowly, the surge current is automatically limited and damage the I.C. is avoided. The maximum forward current of the parasitic diode is approximately 20 mA. In cases where Cx is large the time taken for the supply voltage to fall to 0.4  $V_{\rm CC}$  can be calculated as follows:

$$t_{f} \ge (V_{CC} - 0.7) \cdot Cx/20mA$$

In cases where  $t_f$  is too short an external champing diode is required to protect the I.C. from the surge current.

#### FUNCTIONAL DESCRIPTION

#### Stand-by state

The external capacitor, Cx, is fully charged to V<sub>CC</sub> in the stand-by state. Hence, before triggering, transistor Qp and Qn (connected to the Rx/Cx node) are both turned off. The two comparators that control the timing and the two reference voltage sources stop operating. The total supply current is therefore only leakage current.

#### Trigger operation

Triggering occurs when:

1 st) A is "low" and B has a falling edge; 2 nd) B is "high" and A has a rising edge;

After the multivibrator has been retriggered comparator C1 and C2 start operating and Qn is turned on. Cx then discharges through Qn. The voltage at the node Rx/Cx external falls.

When it reaches V<sub>REFL</sub> the output of comparator C1 becomes low. This in turn resets the flip-flop and Qn is turned off.

At this point C1 stops functioning but C2 continues to operate. The voltage at R/C external begins to rise with a time constant set by the external components Rx, Cx.

Triggering the multivibrator causes Q to go high after internal delay due to the flip-flop and the gate. Q remains high until the voltage at R/C external rises again to V<sub>REFH</sub>. At this point C2 output goes low and G goes low. C2 stops operating. That means that after triggering when the voltage at R/C external returns to V<sub>REFH</sub> the multivibrator has returned to its MONOSTABLE STATE. In the case where Rx • Cx are large enough and the discharge time of the capacitor and the delay time in the I.C. can be ignored, the width of the output pulse tw (out) is as follows:

 $t_{W(OUT)} = 0.72 \text{ Cx} \cdot \text{Rx}$ 

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### FUNCTIONAL DESCRIPTION (Continued)

Re-trigger operation

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When a second trigger pulse follows the first its effect will depend on the state of the multivibrator. If the capacitor Cx is being charged the voltage level of Rx/Cx external falls to V<sub>REFL</sub> again and Q remains high i.e. the retrigger pulse arrives in a time shorter than the period Rx • Cx seconds, the capacitor charging time constant. If the second trigger pulse is very close to the initial trigger pulse it is ineffective; i.e., the second trigger must arrive in the capacitor discharge cycle to be ineffective.

Hence the minimum time for a second trigger to be effective, trr (Min.) depends on V<sub>CC</sub> and Cx.

Reset operation

CD is normally high. If CD is low, the trigger is not effective because Q output goes low and trigger control flip-flop is reset.

Also transistor Op is turned on and Cx is charged quicky to V $_{CC}$ . This means if  $\overline{CD}$  input goes low, the IC becomes waiting state both in operating and non operating state.

### **DC SPECIFICATIONS**

Symbol	Parameter	v <sub>cc</sub>	Test Condition		T <sub>A</sub> = 25°C 54HC and 74HC			- 40 to 85°C 74HC		– 55 to 125°C 54HC		Unit
					Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
VIH	High Level Input Voltage	2.0 4.5 6.0			1.5 3.15 4.2	_	_	1.5 3.15 4.2	<u>-</u>	1.5 3.15 4.2	_ _	v
V <sub>IL</sub>	Low Level Input Voltage	2.0 4.5 6.0				=	0.5 1.35 1.8	<u>-</u>	0.5 1.35 1.8	_	0.5 1.35 1.8	v
V <sub>OH</sub>	High Level Output Voltage (Q, Q Output)	2.0 4.5 6.0 4.5 6.0	V <sub>I</sub> V <sub>IH</sub> or V <sub>IL</sub>	i <sub>O</sub> - 20 μA - 4.0 mA - 5.2 mA	1.9 4.4 5.9 4.18 5.68	2.0 4.5 6.0 4.31 5.8	_ 	1.9 4.4 5.9 4.13 5.63		1.9 4.4 5.9 4.10 5.60		v
V <sub>OL</sub>	Low Level Output Voltage (Q, Q Output)	2.0 4.5 6.0 4.5 6.0	V <sub>IH</sub> or V <sub>IL</sub>	20 μA 4.0 mA 5.2 mA		0.0 0.0 0.0 0.17 0.18	0.1 0.1 0.1 0.26 0.26	- - - - -	0.1 0.1 0.1 0.33 0.33	- - - -	0.1 0.1 0.1 0.40 0.40	v
IN	Input Leakage Current	6.0	V <sub>I</sub> =V	CC or GND		_	±0.1	_	±1.0	_	±1.0	μА
<sup>j</sup> IN	Input Current	6.0	V <sub>I</sub> =V <sub>C</sub> Rext/C	C or GND ext	_		±0.5		±5.0	_	±10	μА
Icc	Quiescent Supply current	6.0	V <sub>I</sub> = V <sub>C</sub>	V <sub>I</sub> =V <sub>CC</sub> or GND		_	4.0	_	40.0	_	80.0	μΑ
lcc	Active State (1) Supply Current	2.0 4.5 6.0	V <sub>I</sub> = V <sub>C</sub> pins 2, V <sub>in</sub> = V		<u>-</u>	40 0.1 0.2	120 0.3 0.6		160 0.4 0.8	_ _	_ _ _	μA mA mA

(1): Per Circuit

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# AC ELECTRICAL CHARACTERISTICS ( $V_{CC} = 5V$ , $T_A = 25$ °C, $C_L = 15$ pF, Input $t_r = t_f = 6$ ns)

		54HC and 74HC						
Symbol	Parameter	Min.	Тур.	Max.	Unit			
t <sub>TLH</sub> t <sub>THL</sub>	Output Transition Time		4	8	ns			
t <sub>PLH</sub>	Propagation Delay Time (A,B-Q,Q)		28	44	ns			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CD-Q,Q)		21	34	ns			

## AC ELECTRICAL CHARACTERISTICS ( $C_L = 50 pF$ , Input $t_f = t_f = 6 ns$ )

Symbol	Parameter	V <sub>CC</sub> Test Condition	T <sub>A</sub> = 25°C 54HC and 74HC			- 40 to 85°C 74HC		– 55 to 125°C 54HC		Unit	
				Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t <sub>TLH</sub> t <sub>THL</sub>	Output Transition Time	2.0 4.5 6.0		_ _ _	30 8 7	75 15 13	_ _ _	95 19 16	_ _ _	110 22 19	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (A, B-Q,Q)	2.0 4.5 6.0			128 32 27	250 50 43	=	315 63 54	=	375 75 64	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CD-Q, Q)	2.0 4.5 6.0		<u>-</u>	100 25 21	195 39 33	_ _ _	245 49 42	=	295 59 50	ns
†wout	Outpul Pulse Width	3.0 5.0	Cx = 12pF Rx = 1kΩ	_	210 140	<u> </u>	_	_	_	_	ns
		3.0 5.0	Cx = 100pF $Rx = 10k\Omega$	_	1.45 1.40	_ _	_ _	_	_	_	μS
		3.0 5.0	Cx = 1000pF Rx = 10kΩ	_	10.5 10	_	-	_	-	-	μS
Δt <sub>WOUT</sub>	Output Pulse Width Error Between Circuits (in Same Package)			-	±1	_	_	_	_	_	%
tw(H) tw(L)	Minimum Trigger Pulse Width	2.0 4.5 6.0	AIN B <sub>IN</sub>	_	30 8 7	75 15 13	_ _	95 19 16		110 22 19	ns
t <sub>W(L)</sub>	Minimum Clear Pulse Width	2.0 4.5 6.0		_	30 8 7	75 15 13	_ _ _	95 19 16	<u> </u>	110 22 19	ns

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### AC ELECTRICAL CHARACTERISTICS (Continued)

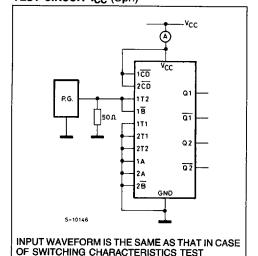
Symbol	Parameter	vcc	Test Condition	T <sub>A</sub> = 25°C 54HC and 74HC			- 40 to 85°C 74HC		- 55 to 125°C 54HC		Unit
				Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t <sub>rr</sub>	Minimum Retrigger	4.5 6.0	Cx = 100pF Rx = 1KΩ	=	74 63	_	_	_	_	_	ns
	Time	4.5 6.0	$Cx = 0.01 \mu F$ $Rx = 1 K\Omega$	_   _	1.1 1.0	=	_	_	_	_	μS
<sup>†</sup> REM	Minimum Clear Removal time	2.0 4.5 6.0		=		0 0 0	_	0		0 0	ns
C <sub>IN</sub>	Input Capacitance			-	5	10	_	10	_	10	рF
C <sub>PD</sub> (*)	Power Dissipation Capacitance			_	90	_	_	_	_	-	рF

Note (\*) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit).

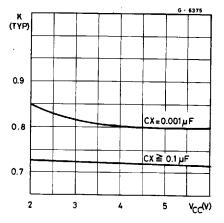
Average operating current can be obtained by the equation hereunder.

I<sub>CC(opr)</sub> = C<sub>PD</sub> · V<sub>CC</sub> · f<sub>IN</sub> + I<sub>CC</sub> · Duty/100 + I<sub>CC</sub>/2 (per monostable) (I<sub>CC</sub> ': Active Supply Current) (Duty: %)

TEST CIRCUIT ICC (Opr.)

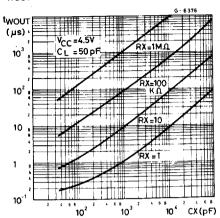


Output Pulse Width Constant K = Supply Voltage

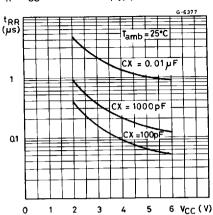


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tWOUT - Cx Characteristics (Typ.)



t<sub>rr</sub> - V<sub>CC</sub> Characteristics (Typ.)



### SWITCHING CHARACTERISTICS TEST WAVEFORM

